	℃			
				℃
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	℃					
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FIG 1:Power dissipation vs. on-state current (per thyristor or diode)

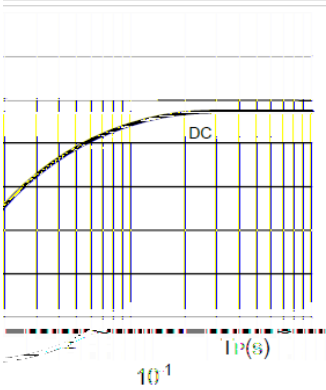


FIG 2: Maximum transient thermal impedance junction to case (per thyristor or diode)

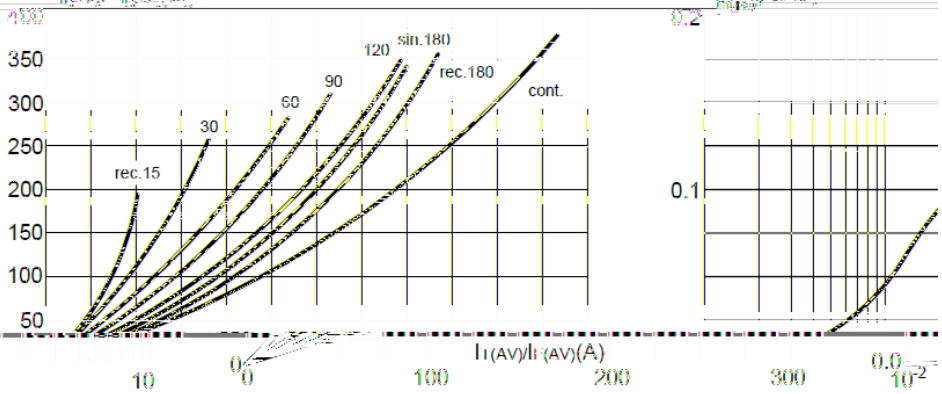


FIG 3: Forward characteristics (per thyristor or diode)

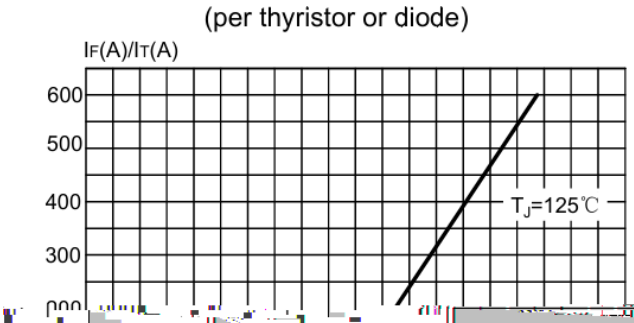


FIG 4: Relative variation of gate trigger current, holding current and latching current versus junction temperature

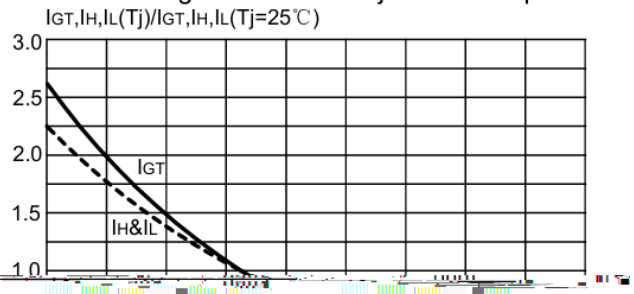


FIG 5 Gate trigger characteristics

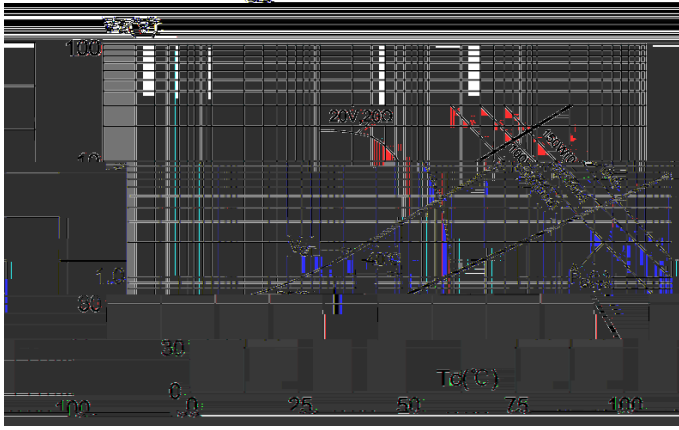
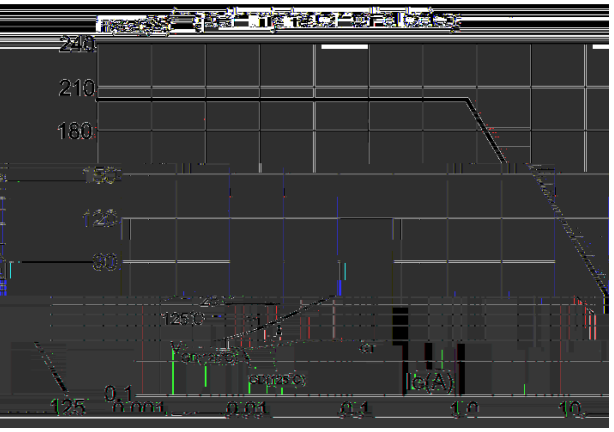
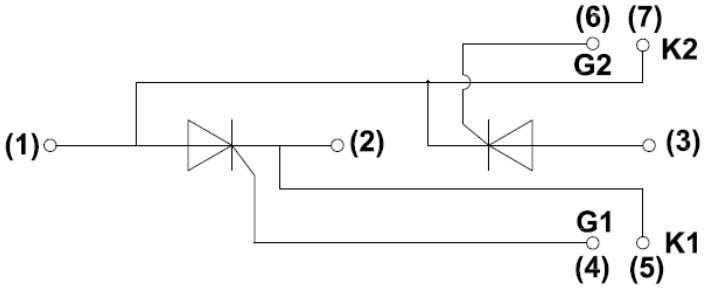
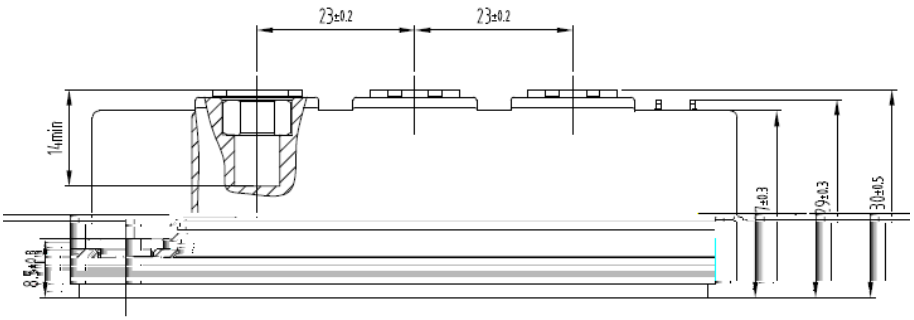
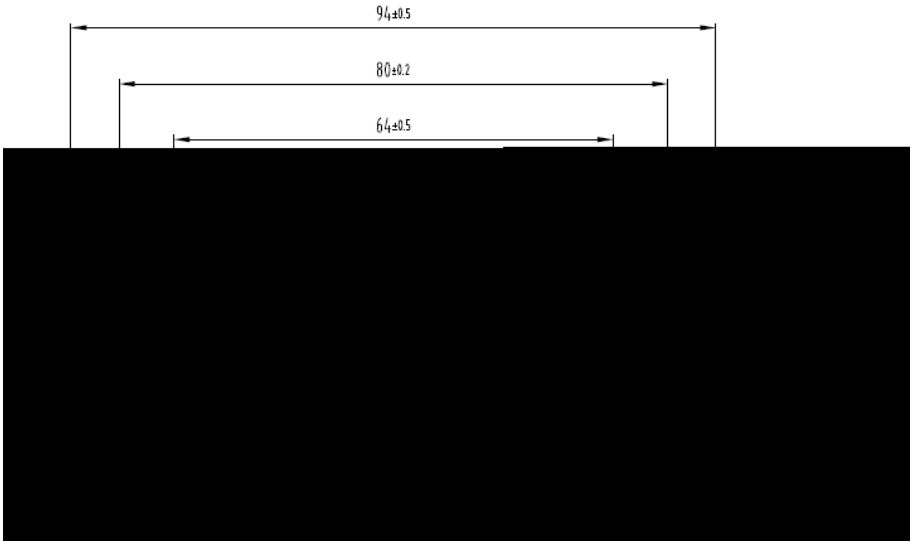


FIG 6: Forward current vs. case temperature




(6)
(7)
G2
K2
(1)
(2)
(3)
G1
K1
(4)
(5)


23±0.2
23±0.2
14min
8.5±0.8
7±0.3
29±0.3
30±0.5


94±0.5
80±0.2
64±0.5